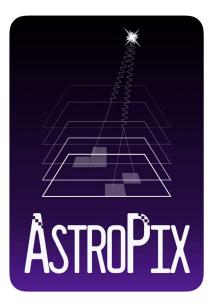
コンプトンカメラ用HV-CMOS: AstroPixの開発現状



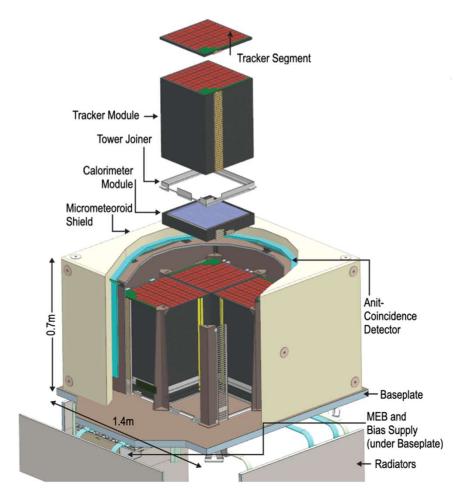
深沢泰司, 須田祐介, 仲野悟帆(広島大学), 田島宏康(名 古屋大学), Regina Caputo, Amanda Steinhebel (GSFC/NASA), 他 AstroPix 開発 team



1日本天文学会春の年会 2024.3.14

All-Sky MeV Gamma-Ray Observatory

 AMEGO-X (PI: R.Caputo GSFC/NASA) is a proposed explorer to study extreme astrophysical phenomena in MeV regime



- Shed light on not-well-studied energy regime (25 keV - 1 GeV)
- Huge impact on multi-messenger astronomy thanks to its wide FoV (2π @ E < 10 MeV)
- Require a lot of low-noise pixelated silicon sensors (~2.4×10⁵ cm²) with a wide depletion layer to efficiently preform Compton reconstruction
- Power consumption of silicon sensors must be < 1 mW/cm²

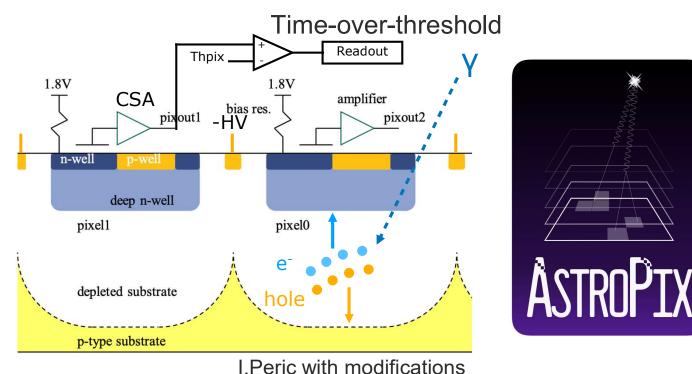


<u> R. Caputo+ 2022</u>

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AstroPix

- AstroPix is a new monolithic HV-CMOS active pixel sensor
 - Full depletion achieved by applying HV
 - Signal processing (CSA → Comparator for Time-over-threshold) is performed on pixel and digitization is done on chip
- Development based on experience from ATLASPix and MuPix

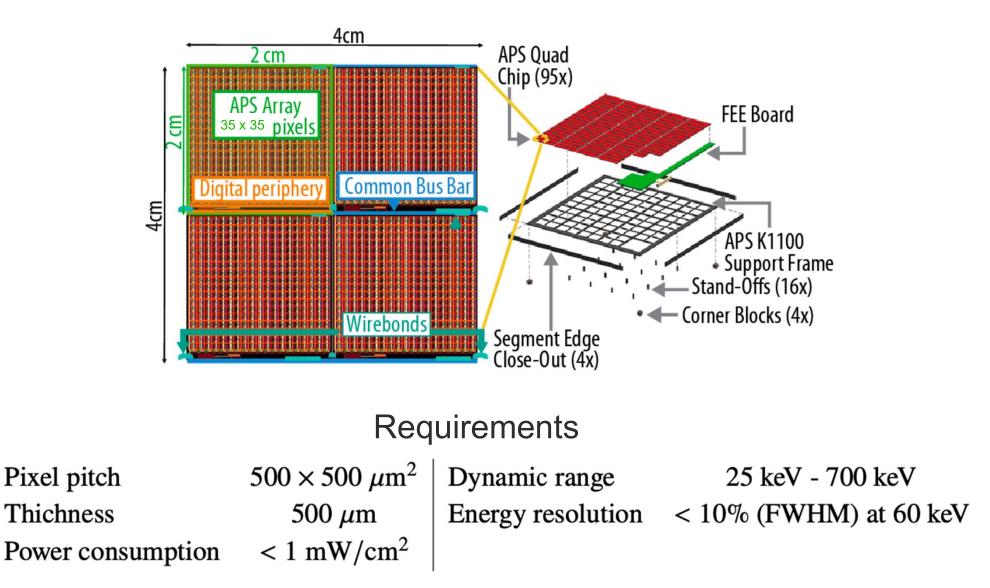


I.Peric&N.Berger 2018

- AstroPix Team
 - PI: R. Caputo (GSFC/NASA)
 - GSFC, ANL, KIT, UCSC, Hiroshima U, Nagoya U

Goal

Quad Chip = 4 identical AstroPix array



4

2023.12.07

AstroPix Series

Version 1

Version 2

AstroPix2

HM01 342 J

Version 3



0.5 x 0.5 cm² chip 175 x 175 µm² pitch 18 x 18 pixels *14.7 mW/cm² *CSA+co

m² chip 1 x 1 cm² chip um² pitch 250 x 250 µm² pitch pixels 35 x 35 pixels N/cm² *3.4 mW/cm² *CSA+comparator only.



2 x 2 cm² chip 500 x 500 µm² pitch 35 x 35 pixels *1.04 mW/cm² 4.12 mW/cm² (incl. digital)

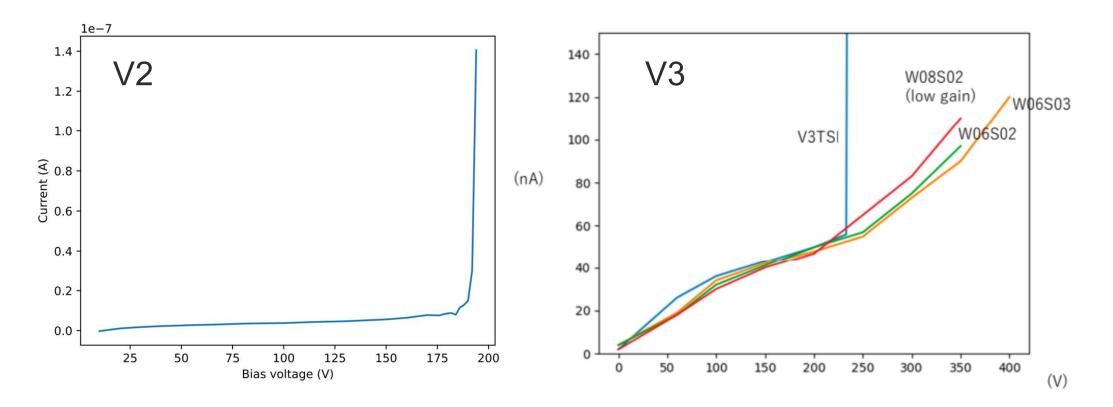
HSTD13

Yusuke Suda

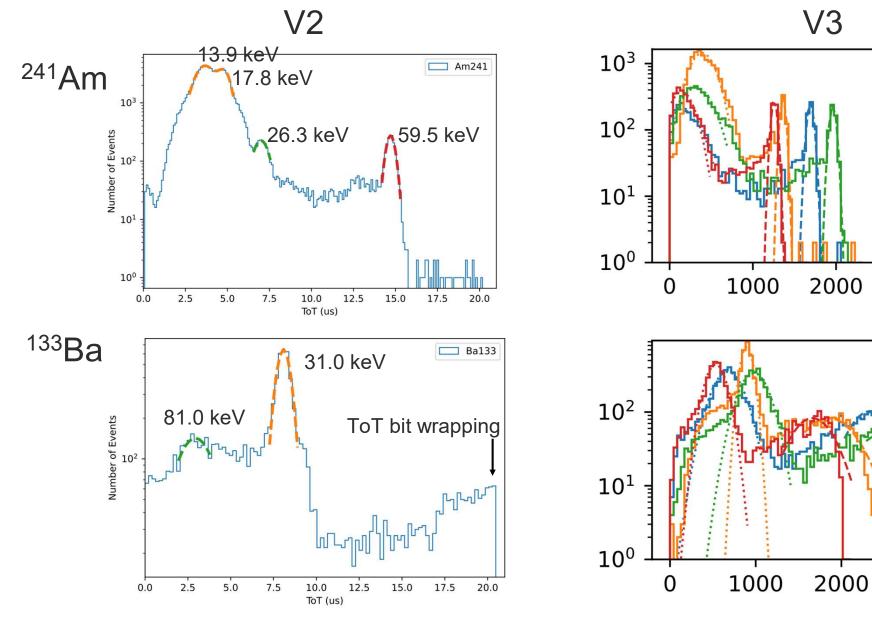
2023.12.07

I-V Curves

- V2: 300 Ωcm wafer chip shows breakdown at ~190 V
- V3: 300 Ωcm wafer chip can go up to ~400 V thanks to better clearance to chip-edge ← Results in this talk from this wafer
 - 20 Ωcm wafer chip breakdown at ~230 V
 - 18 kΩcm wafer chip shows high leakage current in the mA range



Energy Spectra



ToT ch

> HSTD13 2023.12.07

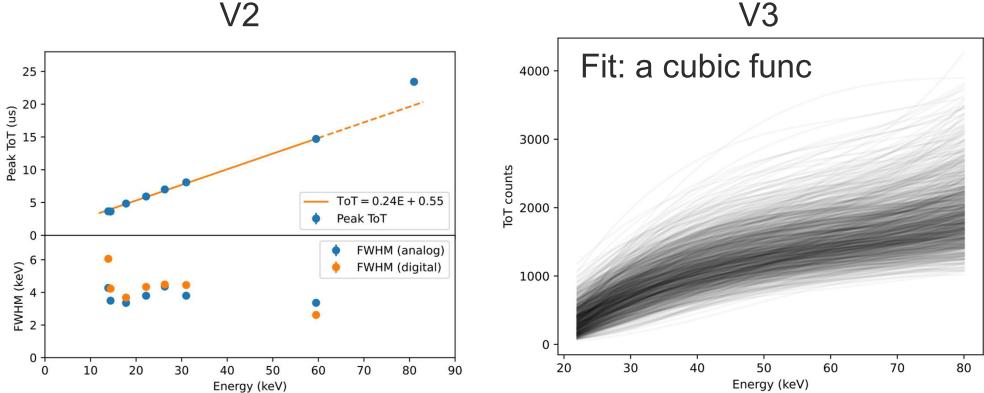
Performance evaluation of the high-voltage CMOS active pixel sensor AstroPix for gamma-ray space telescopes

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T ch

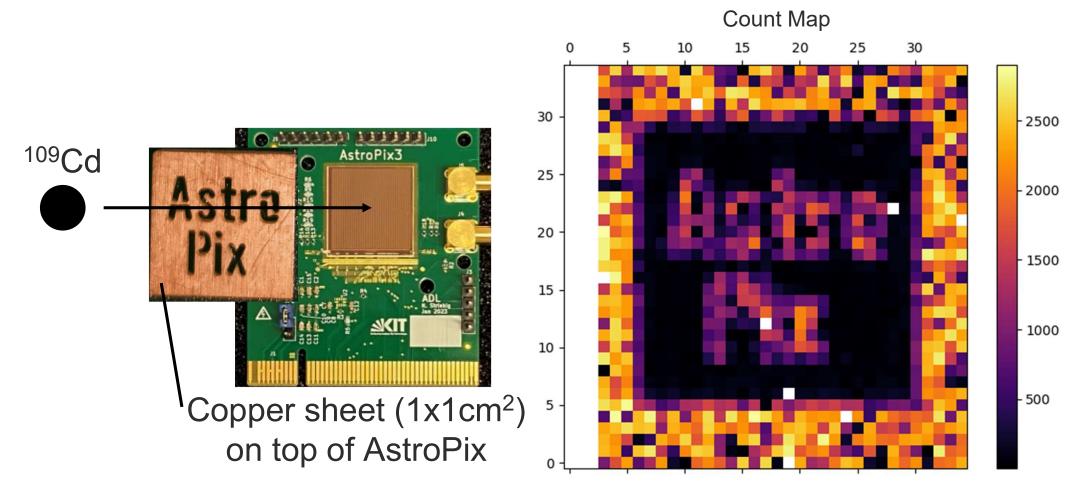
Energy Calibration

- With updated readout FW/SWs for V3, energy calibration can be performed over the full sensor at once
- Dynamic range: 14 80 keV for one pixel of V2 chip 22 - 80 keV for V3 chip



AstroPix V3: Imaging

- First picture taken by AstroPix
- Only 0.7% of pixels are noisy (masked)



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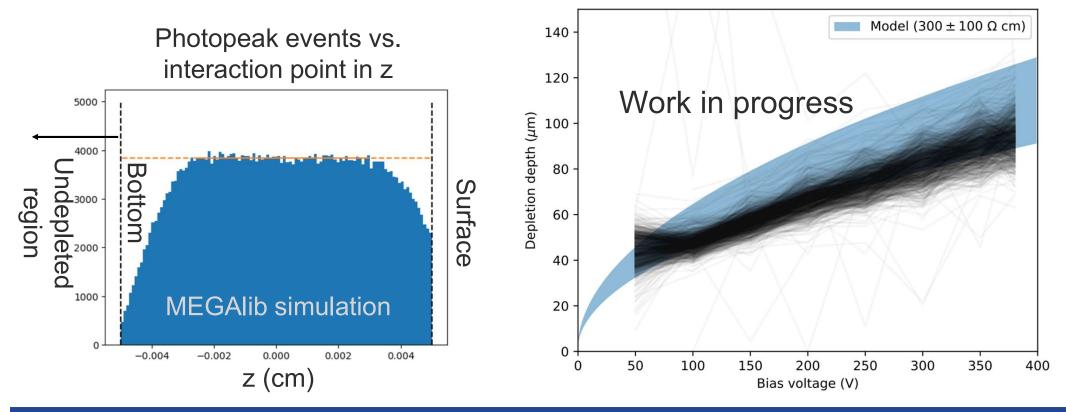
V3: Depletion Depth Measurements

- Estimate from the detection rate of ²⁴¹Am 59.5 keV events
 - Extract photopeak events from the fitted spectrum
- Cu sheet AstroPix Compare with a simple model ²⁴¹Am $d = \sqrt{2\epsilon\mu\rho(V_{\text{bias}} + V_{built-in})}$ 59.5 keV ϵ : Permittivity μ : Hole mobility low-E ho : Resistivity 200-400 Ohm cm X-rays $V_{built-in}$: Built-in potencial Measured ²⁴¹Am spectra Simulated ²⁴¹Am spectra 59.54 keV (all) 27 105 Photo 28 Compton 10² **MEGAlib** simulation 10^{4} 29 30 10³ 10¹ F=Gauss+errf 10² +Gauss 10¹ No noise/Eres simulated 10⁰ 10⁰ 1000 2000 3000 4000 10 20 30 50 60 70 ToT (ch) True energy (keV)

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V3: Depletion Depth Measurements

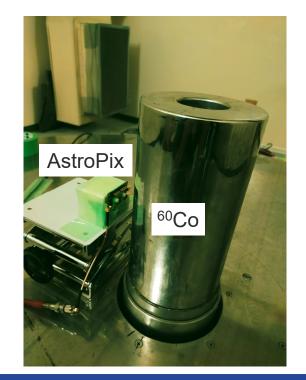
- Sensor volume is corrected for photopeak events
- Measured depths follows the model curve
- Depletion layer develops as expected, but need higher resistivity chips for full depletion

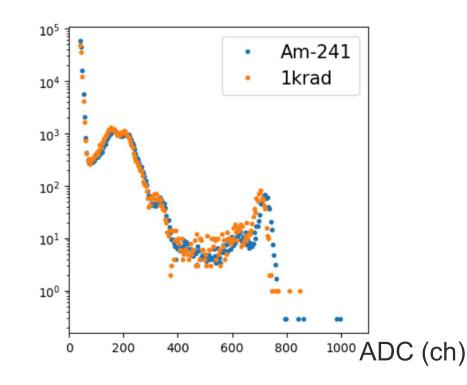


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V2: Radiation Tolerance

- Expect ~1 krad/yr irradiation on orbit
- One of V2 chips was tested at the high intensity ⁶⁰Co facility, Hiroshima U.
- After ~1 krad (assumed. TBC) irradiation, the chip works normally, but current draw increases by ~60% and slight change in gain
- Plan to test with V3 as well

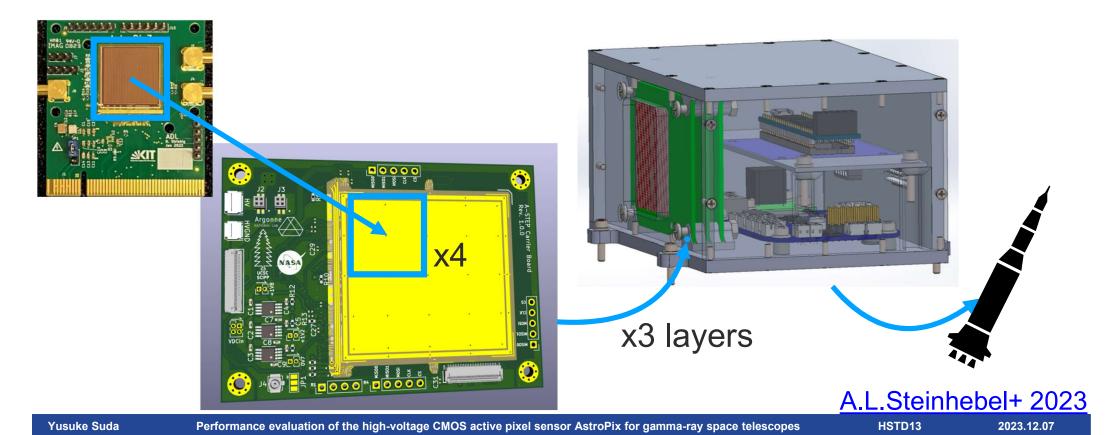




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Quad-Chip

- Minimum component of the AMEGO-X's tracker
- Quad-chip consists of 4 identical V3 chips diced together. Testing will start soon
- Sounding rocket hosted flight ("A-STEP") is planned in summer 2025 to increase Technical Readiness Level



AstroPix V4/5

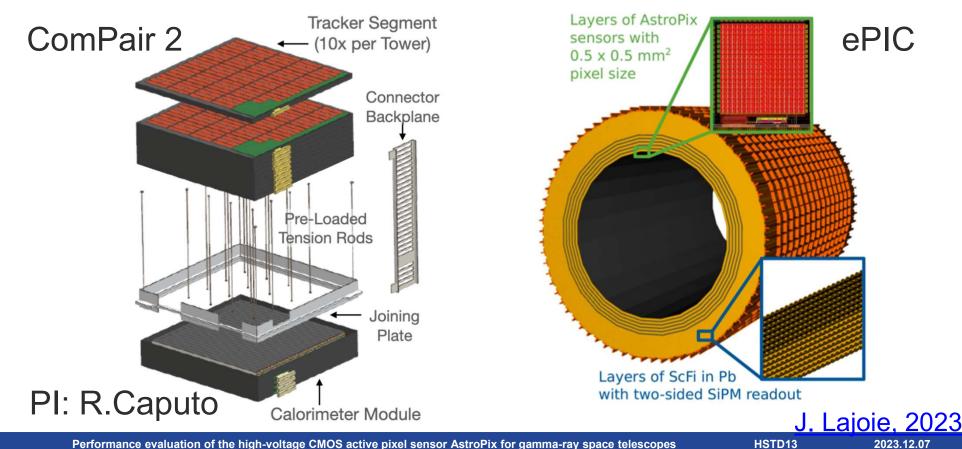
- Asynchronous timestamp clocks to reduce power comsuption
 - Previous: 200 MHz clock → TDC + 20 MHz clock generated by PLL from 2.5 MHz reference clock
- Improved time of arrival resolution: 400 ns \rightarrow 3.125 ns
- Individual tune-DACs for individual pixel calibration/threshold setting
- Lower gain to expand dynamic range
- Will be available to test in this year

N.Striebig+ 2023

Future Projects

Yusuke Suda

- ComPair 2: Compton-Pair telescope prototype
 - Prototype of AMEGO-X's tracker. Instrument integration in 2026
- ePIC detector in Electron Ion Collider (EIC)
 - Imaging electromagnetic calorimeter. AstroPix delivery in 2029



Summary

- AstroPix is a new HV-CMOS active pixel sensor being developed for future gamma-ray telescopes on board
- Pixel pitch in V3 reached to the target size
- Dynamic range is limited to 80 keV. Need to lower gain
- Full energy calibration and full imaging are possible in V3
- Measured depletion depth in V3 shows the depletion layer expands as excepted, but only ~90 um. Need high-p wafer chips designed to lower leakage current
- V3 quad-chips and V4 chips are coming soon